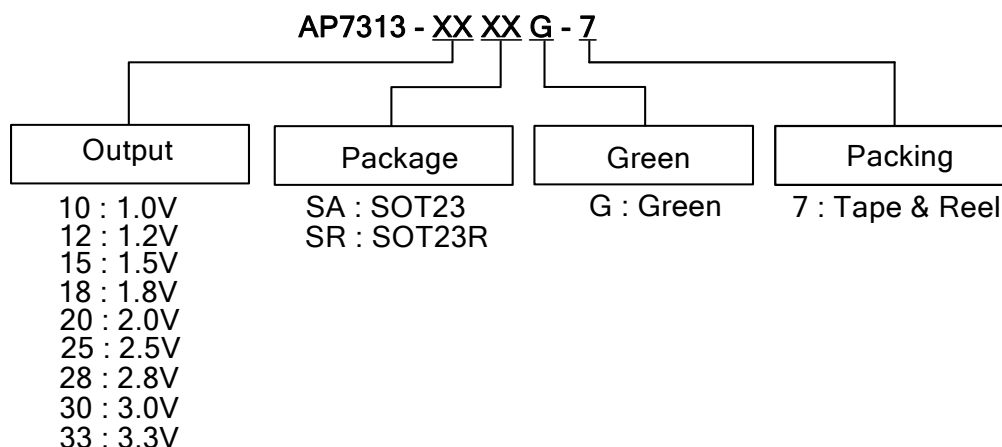


Ordering Information

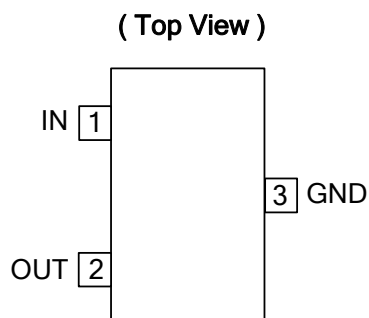


Device	Package Code	Packaging (Note 2)	7" Tape and Reel	
			Quantity	Part Number Suffix
AP7313-XXSAG-7	SA	SOT23	3000/Tape & Reel	-7
AP7313-XXSRG-7	SR	SOT23R	3000/Tape & Reel	-7

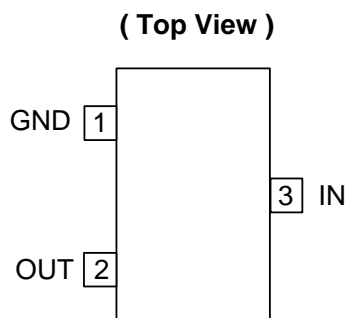
Notes: 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied. Please visit our website at http://www.diodes.com/products/lead_free.html
2. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.

Pin Assignment

(1) SOT23



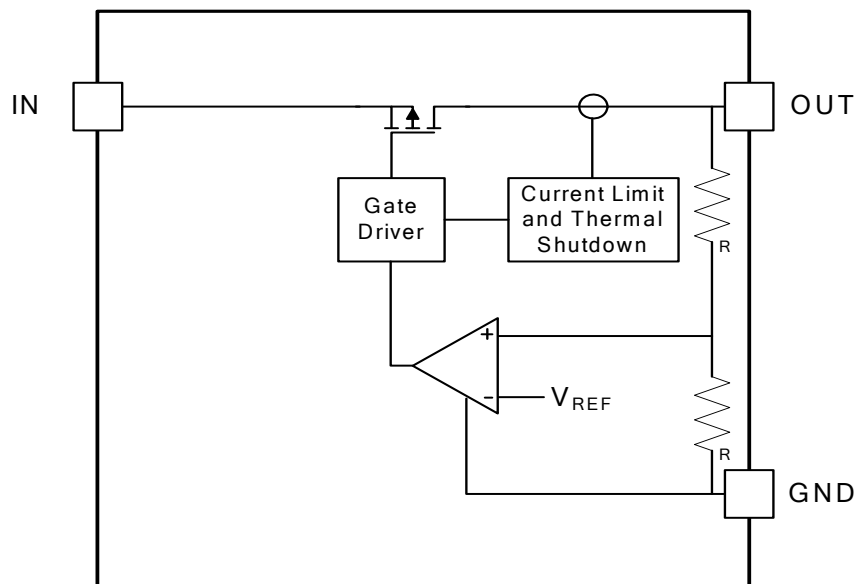
(1) SOT23R



Pin Descriptions

Pin Name	Pin Number		Description
	SOT23	SOT23R	
IN	1	3	Voltage input pin. Bypass to ground through at least 1 μ F capacitor
OUT	2	2	Voltage output pin. Bypass to ground through 1 μ F ceramic capacitor
GND	3	1	Ground

Functional Block Diagram



Absolute Maximum Ratings

Symbol	Parameter	Ratings	Units
ESD HBM	Human Body Model ESD Protection	6	kV
ESD MM	Machine Model ESD Protection	400	V
V_{IN}	Input Voltage	7	V
	Continuous Load Current	Internal Limited	
T_{OP}	Operating Junction Temperature Range	-40 ~ 125	°C
T_{ST}	Storage Temperature Range	-65 ~ 150	°C
P_D	Power Dissipation (Note 3)	SOT23	600
		SOT23R	540
T_J	Maximum Junction Temperature	150	°C

Recommended Operating Conditions

Symbol	Parameter	Min	Max	Unit
V_{IN}	Input voltage	2	6	V
I_{OUT}	Output Current (Note 4)	0	150	mA
T_A	Operating Ambient Temperature	-40	85	°C

Notes: 3. Ratings apply to ambient temperature at 25°C
4. The device maintains a stable, regulated output voltage without a load current.

Electrical Characteristics

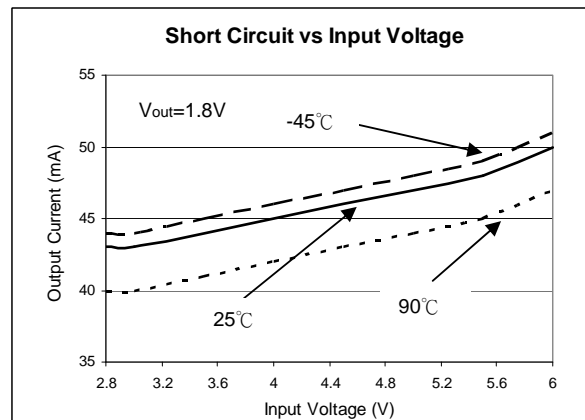
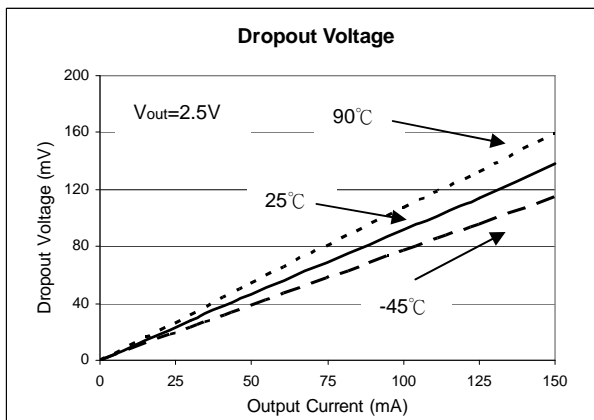
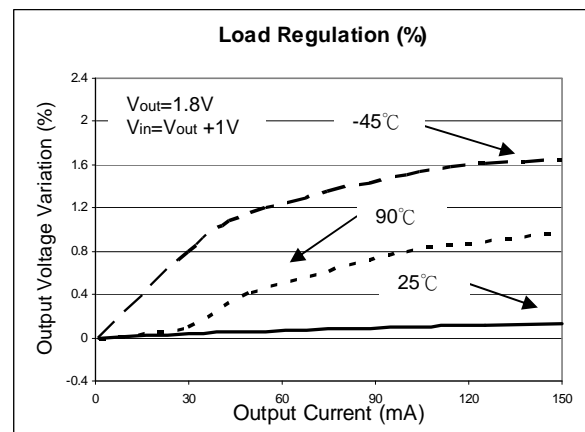
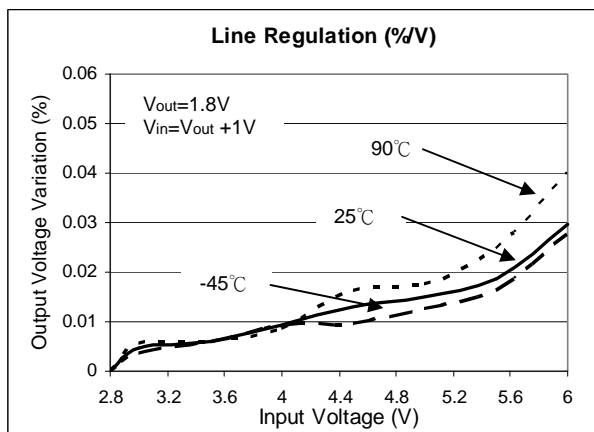
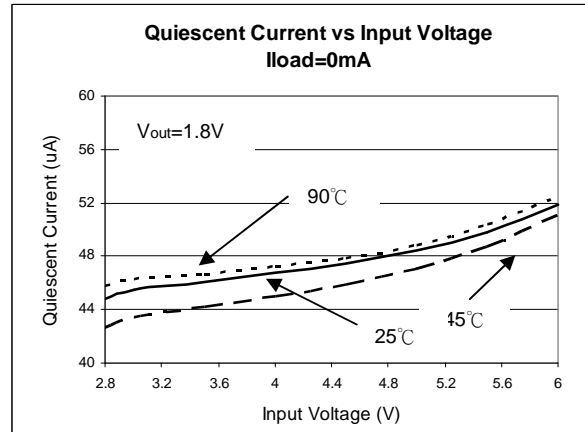
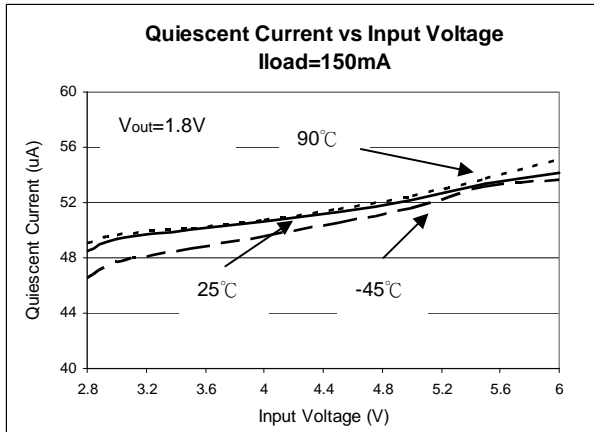
($T_A = 25^\circ\text{C}$, $V_{IN} = V_{OUT} + 1\text{V}$, $C_{IN} = 1\mu\text{F}$, $C_{OUT} = 1\mu\text{F}$, unless otherwise stated)

Symbol	Parameter	Test Conditions	Min	Typ.	Max	Unit
I_Q	Input Quiescent Current	$I_{OUT} = 0\text{mA}$	—	55	75	μA
		$I_{OUT} = 150\text{mA}$		65	85	
$V_{Dropout}$	Dropout Voltage (Note 5)	$I_{OUT} = 150\text{mA}$		150	300	mV
V_{OUT}	Output Voltage Accuracy	$T_A = -40^\circ\text{C}$ to 85°C , $I_{OUT} = 30\text{mA}$	-2		2	%
$\frac{\Delta V_{OUT}}{\Delta V_{IN}/V}$	Line Regulation	$V_{IN} = (V_{OUT} + 1\text{V})$ to V_{IN-Max} , $I_{OUT} = 1\text{mA}$		0.01	0.20	%/V
$\frac{\Delta V_{OUT}}{I_{OUT}}$	Load Regulation	$V_{IN} = (V_{OUT} + 1\text{V})$ to V_{IN-Max} , I_{OUT} from 1mA to 150mA	-0.6		0.6	%
t_{ST}	Start-up Time	$V_{EN} = 0\text{V}$ to 2.0V , $V_{OUT} = 1.8\text{V}$ $I_{OUT} = 150\text{mA}$		80		μs
PSRR	PSRR	$V_{IN} = [V_{OUT} + 1\text{V}]V_{DC} + 0.5V_{ppAC}$, $f = 100\text{Hz}$, $I_{OUT} = 30\text{mA}$		65		dB
I_{SHORT}	Short-circuit Current	$V_{IN} = V_{IN-Min}$ to V_{IN-Max} , $V_{OUT} < 0.2\text{V}$		50		mA
I_{LIMIT}	Current limit	$V_{IN} = (V_{OUT} + 1\text{V})$ to V_{IN-Max} , $V_{OUT}/R_{OUT} = 0.5\text{A}$	200	300		mA
T_{SHDN}	Thermal shutdown threshold			140		$^\circ\text{C}$
T_{HYS}	Thermal shutdown hysteresis			15		$^\circ\text{C}$
θ_{JA}	Thermal Resistance Junction-to-Ambient	SOT23 (Note 6)		207		$^\circ\text{C/W}$
		SOT23R (Note 6)		230		$^\circ\text{C/W}$

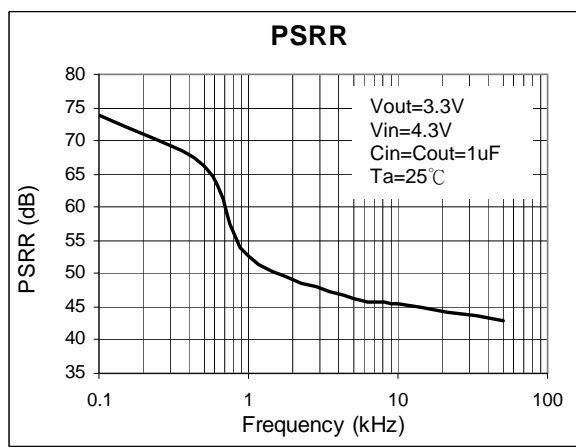
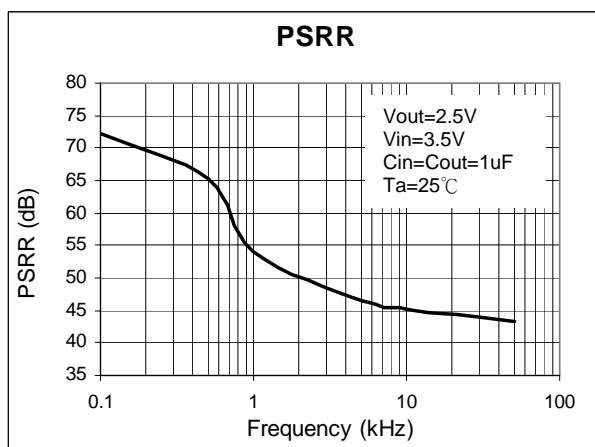
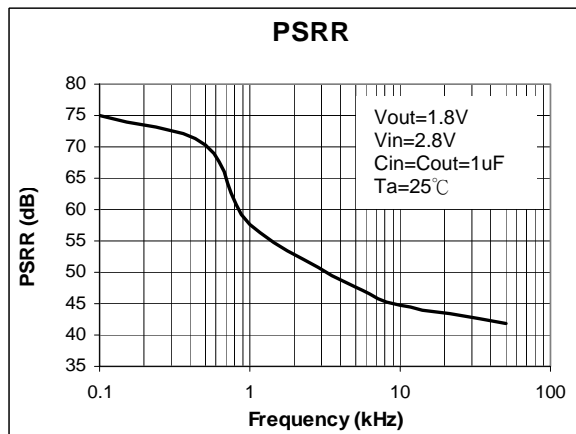
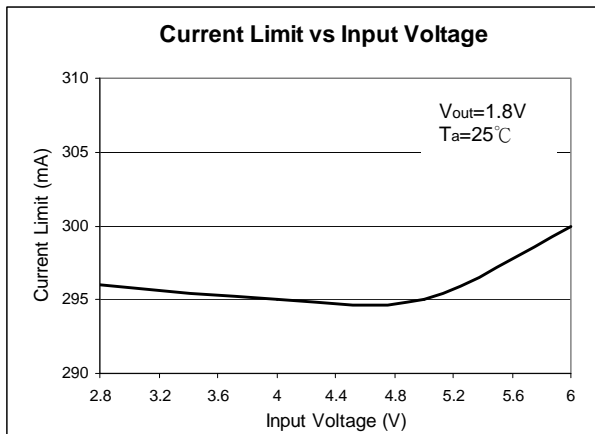
Notes: 5. Dropout voltage is the voltage difference between the input and the output at which the output voltage drops 2% below its nominal value. This parameter only applies to output voltages above 1.8V.

6. Test conditions for SOT23 and SOT23R: Device mounted on FR-4 substrate PCB, with minimum recommended pad layout, 2oz copper, single sided.

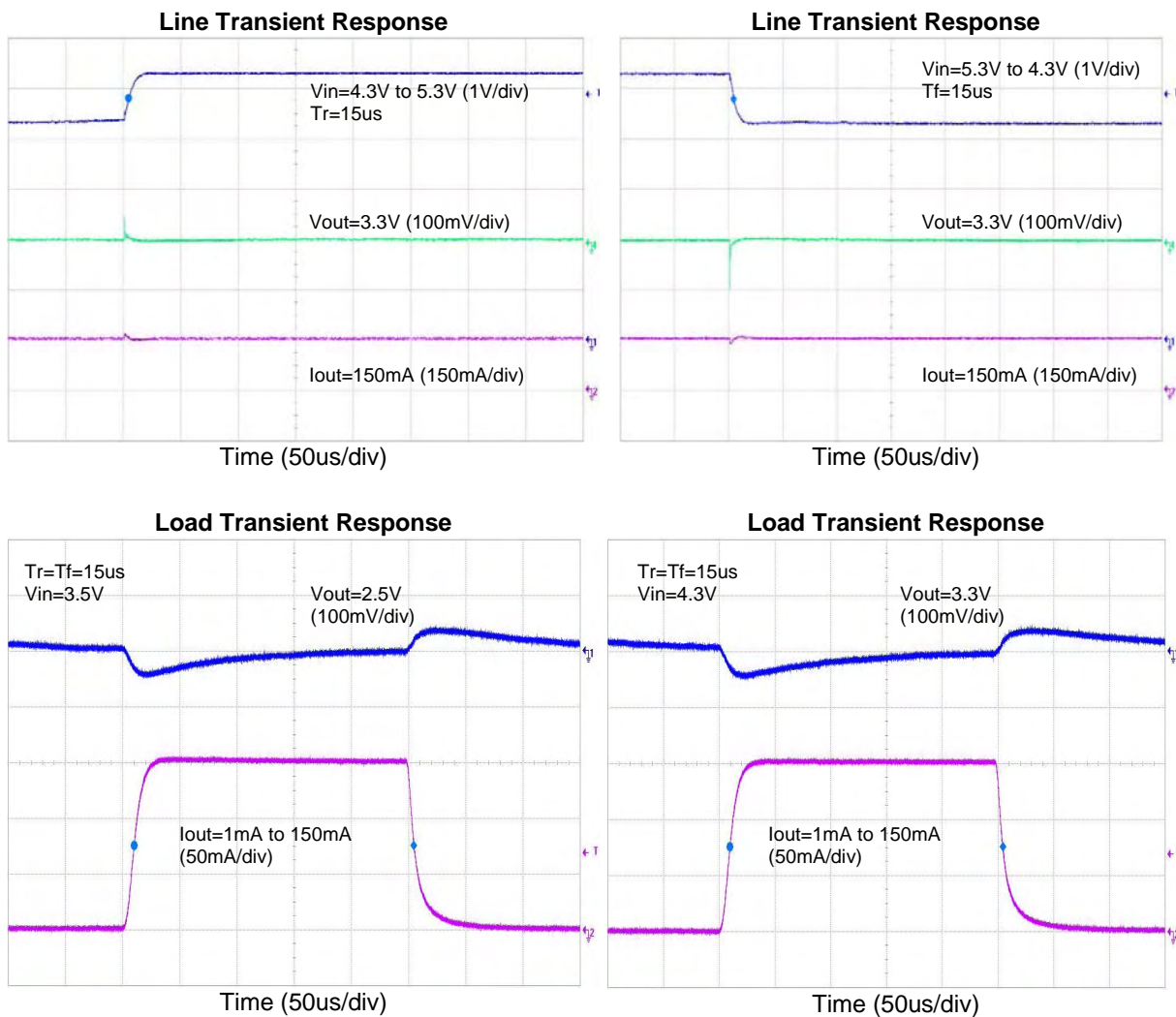
Typical Performance Characteristics



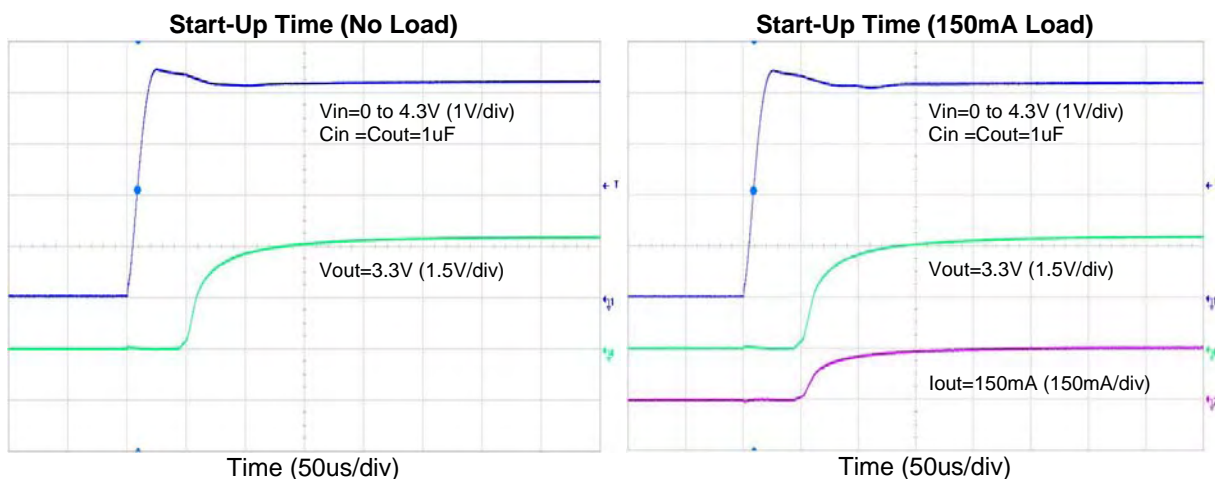
Typical Performance Characteristics (Continued)



Typical Performance Characteristics (Continued)



Typical Performance Characteristics (Continued)



Application Note

Input Capacitor

A 1 μ F ceramic capacitor is recommended to connect between V_{IN} and GND pins to decouple input power supply glitch and noise. The amount of the capacitance may be increased without limit. This input capacitor must be located as close as possible to the device to assure input stability and less noise. For PCB layout, a wide copper trace is required for both V_{IN} and GND. A lower ESR capacitor allows the use of less capacitance, while higher ESR type requires more capacitance.

Output Capacitor

The output capacitor is required to stabilize and help transient response for LDO. The AP7313 is stable with very small ceramic output capacitors. The recommended capacitance is from 1 μ F to 4.7 μ F, Equivalent Series Resistance (ESR) is from 10m Ω to 200m Ω , and temperature characteristic is X7R or X5R. Higher capacitance values help to improve load/line transient response. The output capacitance may be increased to keep low undershoot/overshoot. Place output capacitor as close as possible to OUT and GND pins, and keep the leads as short as possible.

No Load Stability

No minimum load is required to keep the device stable. The device will remain stable and regulated in no load condition.

Current Limit Protection

When output current at OUT pin is higher than current limit threshold, the current limit protection will be triggered and clamp the output current to approximately 300mA to prevent over-current and to protect the regulator from damage due to overheating.

Short Circuit Protection

When OUT pin is short-circuit to GND or OUT pin voltage is less than 200mV, short circuit protection will be triggered and clamp the output current to approximately 50mA. This feature protects the regulator from over-current and damage due to overheating.

Thermal Shutdown Protection

Thermal protection disables the output when the junction temperature rises to approximately +140°C, allowing the device

to cool down. When the junction temperature reduces to approximately +125°C the output circuitry is enabled again. Depending on power dissipation, thermal resistance, and ambient temperature, the thermal protection circuit may cycle on and off. This cycling limits the heat dissipation of the regulator, protecting it from damage due to overheating.

Ultra Fast Start-up

After turned on, the AP7313 is able to provide full power in as little as tens of microseconds, typically 80 μ s, without sacrificing low ground current. This feature will help load circuitry move in and out of standby mode in real time, eventually extend battery life for mobile phones and other portable devices.

Fast Transient Response

Fast transient response LDOs can also extend battery life. TDMA-based cell phone protocols such as Global System for Mobile Communications (GSM) have a transmit/receive duty factor of only 12.5 percent, enabling power savings by putting much of the baseband circuitry into standby mode in between transmit cycles. In baseband circuits, the load often transitions virtually instantaneously from 100 μ A to 100mA. To meet this load requirement, the LDO must react very quickly without a large voltage drop or overshoot — a requirement that cannot be met with conventional, general-purpose LDOs.

The AP7313's fast transient response from 0 to 150mA provides stable voltage supply for fast DSP and GSM chipset with fast changing load.

Small Overshoot and Undershoot

The AP7313 has small and controlled overshoot and undershoot in load and line transitions. This helps to protect supplied circuit from damage and operation error caused by glitches. This feature also permits the usage of small value output decoupling capacitor with AP7313.

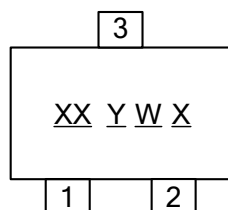
Low Quiescent Current

The AP7313, consuming only around 65 μ A for all input range and output loading, provides great power saving in portable and low power applications.

Wide Output Options

The AP7313, with multiples of fixed output voltage options, provides a versatile LDO solution for many portable applications.

Marking Information

(1) SOT23 and SOT23R
(Top View)

XX : Identification code

Y : Year 0~9

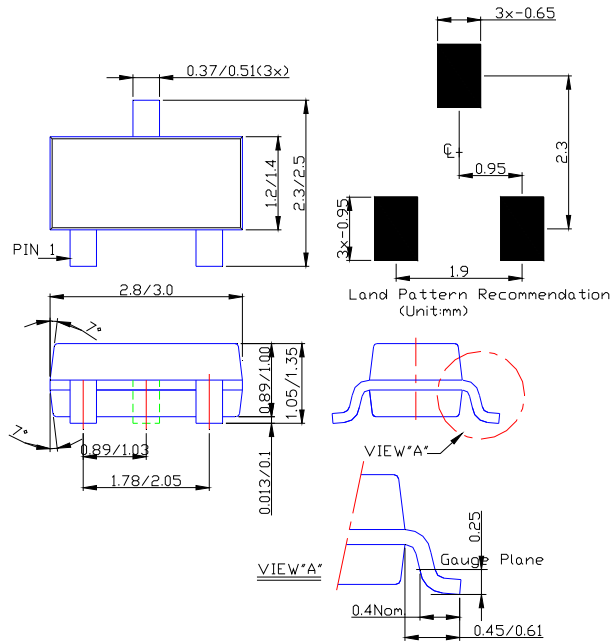
W : Week : A~Z : 1~26 week;
 a~z : 27~52 week; z represents
 52 and 53 week

X : A~Z : Green

Device	Package	Identification Code
AP7313-10SA	SOT23	NR
AP7313-12SA	SOT23	NS
AP7313-15SA	SOT23	NT
AP7313-18SA	SOT23	NU
AP7313-20SA	SOT23	NV
AP7313-25SA	SOT23	NW
AP7313-28SA	SOT23	NX
AP7313-30SA	SOT23	NY
AP7313-33SA	SOT23	NZ
AP7313-10SR	SOT23R	SA
AP7313-12SR	SOT23R	SB
AP7313-15SR	SOT23R	SC
AP7313-18SR	SOT23R	SD
AP7313-20SR	SOT23R	SE
AP7313-25SR	SOT23R	SF
AP7313-28SR	SOT23R	SG
AP7313-30SR	SOT23R	SH
AP7313-33SR	SOT23R	SJ

Package Information (All Dimensions in mm)

(1) Package Type: SOT23 and SOT23R



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